# imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



## Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



## Features

- Low-voltage and Standard-voltage Operation
  - $-2.7 (V_{CC} = 2.7V \text{ to } 5.5V)$
  - 1.8 (V<sub>CC</sub> = 1.8V to 5.5V)
- Internally Organized 128 x 8 (1K), 256 x 8 (2K), 512 x 8 (4K), 1024 x 8 (8K) or 2048 x 8 (16K)
- 2-wire Serial Interface
- Schmitt Trigger, Filtered Inputs for Noise Suppression
- Bi-directional Data Transfer Protocol
- 100 kHz (1.8V) and 400 kHz (2.5V, 2.7V, 5V) Compatibility
- Write Protect Pin for Hardware Data Protection
- 8-byte Page (1K, 2K), 16-byte Page (4K, 8K, 16K) Write Modes
- Partial Page Writes are Allowed
- Self-timed Write Cycle (5 ms max)
- High-reliability
  - Endurance: 1 Million Write Cycles
  - Data Retention: 100 Years
- Automotive Grade, Extended Temperature and Lead-free/Halogen-free Devices Available
- 8-lead PDIP, 8-lead JEDEC SOIC, 8-lead MAP, 5-lead SOT23, 8-lead TSSOP and 8-ball dBGA2<sup>™</sup> Packages

## Description

The AT24C01A/02/04/08/16 provides 1024/2048/4096/8192/16384 bits of serial electrically erasable and programmable read-only memory (EEPROM) organized as 128/256/512/1024/2048 words of 8 bits each. The device is optimized for use in many industrial and commercial applications where low-power and low-voltage operation are essential. The AT24C01A/02/04/08/16 is available in space-saving 8-lead PDIP, 8-lead JEDEC SOIC, 8-lead MAP, 5-lead SOT23 (AT24C01A/AT24C02/AT24C04), 8-lead TSSOP and 8-ball dBGA2 packages and is accessed via a 2-wire serial interface. In addition, the entire family is available in 2.7V (2.7V to 5.5V) and 1.8V (1.8V to 5.5V) versions.

Pin Con	figurations	ع A0				A0 🖂	8-lead SOIC	CC
Pin Name	Function		2				2 7 W	-
A0 - A2	Address Inputs		3 4		6 🗆 SCL 5 🗆 SDA			CL DA
SDA	Serial Data					L		
SCL	Serial Clock Input	8-	ball d	dBGA	<b>\</b> 2	8-	lead MAP	
WP	Write Protect	VCC	8	1	AO	VCC 8		
NC	No Connect	WP	1	2	A1	WP Z	2 A1	
GND	Ground	SCL SDA	6 5	3 4	A2 GND	SCL 6 SDA 5		
VCC	Power Supply		otton	n Vie	J W	Bo	ottom View	
8-lea		5-lea	d SC	DT23			OT23 Rotated (R) (1k only)	
A0 □ 1 A1 □ 2 A2 □ 3 GND □ 4	8 □ VCC 7 □ WP 6 □ SCL 5 □ SDA	SCL 1 GND 2 SDA 3		4	∃WP ⊒VCC		1 5 VCC 2 3 4 NC	



2-wire Serial EEPROM

1K (128 x 8)

2K (256 x 8)

4K (512 x 8)

8K (1024 x 8)

16K (2048 x 8)

## AT24C01A AT24C02 AT24C04 AT24C08<sup>(1)</sup> AT24C16<sup>(2)</sup>

Note: 1. This device is not recommended for new designs. Please refer to AT24C08A.

 This device is not recommended for new designs. Please refer to AT24C16A.





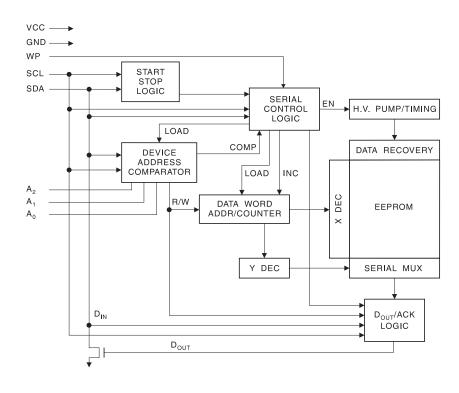


## **Absolute Maximum Ratings**

Operating Temperature55°C to +125°C	;
Storage Temperature65°C to +150°C	;
Voltage on Any Pin with Respect to Ground1.0V to +7.0V	,
Maximum Operating Voltage 6.25V	/
DC Output Current 5.0 mA	•

\*NOTICE: Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## **Block Diagram**



## **Pin Description** SERIAL CLOCK (SCL): The SCL input is used to positive edge clock data into each EEPROM device and negative edge clock data out of each device.

**SERIAL DATA (SDA):** The SDA pin is bi-directional for serial data transfer. This pin is open-drain driven and may be wire-ORed with any number of other open-drain or open-collector devices.

**DEVICE/PAGE ADDRESSES (A2, A1, A0):** The A2, A1 and A0 pins are device address inputs that are hard wired for the AT24C01A and the AT24C02. As many as eight 1K/2K devices may be addressed on a single bus system (device addressing is discussed in detail under the Device Addressing section).

The AT24C04 uses the A2 and A1 inputs for hard wire addressing and a total of four 4K devices may be addressed on a single bus system. The A0 pin is a no connect.

The AT24C08 only uses the A2 input for hardwire addressing and a total of two 8K devices may be addressed on a single bus system. The A0 and A1 pins are no connects.

The AT24C16 does not use the device address pins, which limits the number of devices on a single bus to one. The A0, A1 and A2 pins are no connects.

**WRITE PROTECT (WP):** The AT24C01A/02/04/16 has a Write Protect pin that provides hardware data protection. The Write Protect pin allows normal read/write operations when connected to ground (GND). When the Write Protect pin is connected to  $V_{CC}$ , the write protection feature is enabled and operates as shown in the following table.

WP Pin		Part of the Array Protected						
Status	24C01A	24C02	24C04	<b>24C08</b> <sup>(1)</sup>	24C16 <sup>(2)</sup>			
At V <sub>CC</sub>	Full (1K) Array	Full (2K) Array	Full (4K) Array	Normal Read/ Write Operation	Upper Half (8K) Array			
At GND	Normal Read/V	Vrite Operations						

Notes: 1. This device is not recommended for new designs. Please refer to AT24C08A.

2. This device is not recommended for new designs. Please refer to AT24C16A.

### **Memory Organization**

**AT24C01A, 1K SERIAL EEPROM:** Internally organized with 16 pages of 8 bytes each, the 1K requires a 7-bit data word address for random word addressing.

**AT24C02, 2K SERIAL EEPROM:** Internally organized with 32 pages of 8 bytes each, the 2K requires an 8-bit data word address for random word addressing.

**AT24C04, 4K SERIAL EEPROM:** Internally organized with 32 pages of 16 bytes each, the 4K requires a 9-bit data word address for random word addressing.

**AT24C08, 8K SERIAL EEPROM:** Internally organized with 64 pages of 16 bytes each, the 8K requires a 10-bit data word address for random word addressing.

**AT24C16, 16K SERIAL EEPROM:** Internally organized with 128 pages of 16 bytes each, the 16K requires an 11-bit data word address for random word addressing.





## Pin Capacitance<sup>(1)</sup>

Applicable over recommended operating range from  $T_A = 25^{\circ}C$ , f = 1.0 MHz,  $V_{CC} = +1.8V$ .

Symbol	Test Condition	Мах	Units	Conditions
C <sub>I/O</sub>	Input/Output Capacitance (SDA)	8	pF	$V_{I/O} = 0V$
C <sub>IN</sub>	Input Capacitance (A <sub>0</sub> , A <sub>1</sub> , A <sub>2</sub> , SCL)	6	pF	$V_{IN} = 0V$

Note: 1. This parameter is characterized and is not 100% tested.

### **DC Characteristics**

Applicable over recommended operating range from:  $T_{AI} = -40^{\circ}C$  to  $+85^{\circ}C$ ,  $V_{CC} = +1.8V$  to +5.5V,  $T_{AE} = -40^{\circ}C$  to  $+125^{\circ}C$ ,  $V_{CC} = +1.8V$  to +5.5V (unless otherwise noted).

Symbol	Parameter	Test Condition	Min	Тур	Max	Units
V <sub>CC1</sub>	Supply Voltage		1.8		5.5	V
V <sub>CC2</sub>	Supply Voltage		2.5		5.5	V
V <sub>CC3</sub>	Supply Voltage		2.7		5.5	V
V <sub>CC4</sub>	Supply Voltage		4.5		5.5	V
I <sub>CC</sub>	Supply Current V <sub>CC</sub> = 5.0V	READ at 100 kHz		0.4	1.0	mA
I <sub>CC</sub>	Supply Current V <sub>CC</sub> = 5.0V	WRITE at 100 kHz		2.0	3.0	mA
I <sub>SB1</sub>	Standby Current V <sub>CC</sub> = 1.8V	$V_{IN} = V_{CC} \text{ or } V_{SS}$		0.6	3.0	μA
I <sub>SB2</sub>	Standby Current V <sub>CC</sub> = 2.5V	$V_{IN} = V_{CC} \text{ or } V_{SS}$		1.4	4.0	μA
I <sub>SB3</sub>	Standby Current V <sub>CC</sub> = 2.7V	$V_{IN} = V_{CC} \text{ or } V_{SS}$		1.6	4.0	μA
I <sub>SB4</sub>	Standby Current $V_{CC} = 5.0V$	$V_{IN} = V_{CC} \text{ or } V_{SS}$		8.0	18.0	μA
ILI	Input Leakage Current	$V_{IN} = V_{CC} \text{ or } V_{SS}$		0.10	3.0	μA
I <sub>LO</sub>	Output Leakage Current	$V_{OUT} = V_{CC} \text{ or } V_{SS}$		0.05	3.0	μA
V <sub>IL</sub>	Input Low Level <sup>(1)</sup>		-0.6		V <sub>CC</sub> x 0.3	V
V <sub>IH</sub>	Input High Level <sup>(1)</sup>		V <sub>CC</sub> x 0.7		V <sub>CC</sub> + 0.5	V
V <sub>OL2</sub>	Output Low Level V <sub>CC</sub> = 3.0V	I <sub>OL</sub> = 2.1 mA			0.4	V
V <sub>OL1</sub>	Output Low Level V <sub>CC</sub> = 1.8V	I <sub>OL</sub> = 0.15 mA			0.2	V

Note: 1.  $V_{IL}$  min and  $V_{IH}$  max are reference only and are not tested.

### **AC Characteristics**

Applicable over recommended operating range from  $T_{AI} = -40^{\circ}C$  to  $+85^{\circ}C$ ,  $V_{CC} = +1.8V$  to +5.5V,  $T_{AE} = -40^{\circ}C$  to  $+125^{\circ}C$ ,  $V_{CC} = +2.7V$  to +5.5V, CL = 1 TTL Gate and 100 pF (unless otherwise noted).

	Parameter	1.8	-volt	2.5, 2.7,	5.0-volt	
Symbol		Min	Мах	Min	Мах	Units
f <sub>SCL</sub>	Clock Frequency, SCL		100		400 <sup>(1)</sup>	kHz
t <sub>LOW</sub>	Clock Pulse Width Low	4.7		1.2		μs
t <sub>HIGH</sub>	Clock Pulse Width High	4.0		0.6		μs
t <sub>I</sub>	Noise Suppression Time <sup>(2)</sup>		100		50	ns
t <sub>AA</sub>	Clock Low to Data Out Valid	0.1	4.5	0.1	0.9	μs
t <sub>BUF</sub>	Time the bus must be free before a new transmission can start <sup>(2)</sup>	4.7		1.2		μs
t <sub>HD.STA</sub>	Start Hold Time	4.0		0.6		μs
t <sub>SU.STA</sub>	Start Setup Time	4.7		0.6		μs
t <sub>HD.DAT</sub>	Data In Hold Time	0		0		μs
t <sub>SU.DAT</sub>	Data In Setup Time	200		100		ns
t <sub>R</sub>	Inputs Rise Time <sup>(2)</sup>		1.0		0.3	μs
t <sub>F</sub>	Inputs Fall Time <sup>(2)</sup>		300		300	ns
t <sub>SU.STO</sub>	Stop Setup Time	4.7		0.6		μs
t <sub>DH</sub>	Data Out Hold Time	100		50		ns
t <sub>wR</sub>	Write Cycle Time		5		5	ms
Endurance <sup>(1)</sup>	5.0V, 25°C, Byte Mode	1M		1M		Write Cycles

Note: 1. The 24C01A/02/04 bearing the process letter "D" on the package (the mark is located in the lower right corner on the top side of the package), guarantees 400 kHz (2.5 – 5.0V).

2. This parameter is characterized and is not 100% tested.





### **Device Operation**

**CLOCK and DATA TRANSITIONS:** The SDA pin is normally pulled high with an external device. Data on the SDA pin may change only during SCL low time periods (refer to Data Validity timing diagram). Data changes during SCL high periods will indicate a start or stop condition as defined below.

**START CONDITION:** A high-to-low transition of SDA with SCL high is a start condition which must precede any other command (refer to Start and Stop Definition timing diagram).

**STOP CONDITION:** A low-to-high transition of SDA with SCL high is a stop condition. After a read sequence, the stop command will place the EEPROM in a standby power mode (refer to Start and Stop Definition timing diagram).

**ACKNOWLEDGE:** All addresses and data words are serially transmitted to and from the EEPROM in 8-bit words. The EEPROM sends a zero to acknowledge that it has received each word. This happens during the ninth clock cycle.

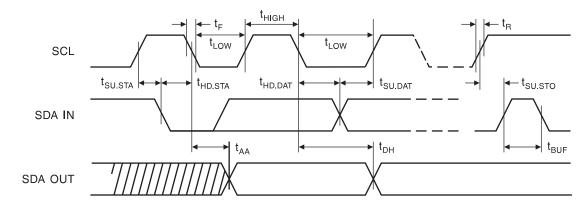
**STANDBY MODE:** The AT24C01A/02/04/08/16 features a low-power standby mode which is enabled: (a) upon power-up and (b) after the receipt of the STOP bit and the completion of any internal operations.

**MEMORY RESET:** After an interruption in protocol, power loss or system reset, any 2wire part can be reset by following these steps:

- 1. Clock up to 9 cycles.
- 2. Look for SDA high in each cycle while SCL is high.
- 3. Create a start condition.

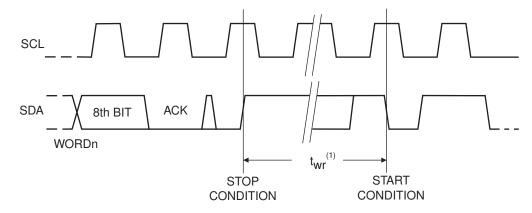
## **Bus Timing**

### SCL: Serial Clock, SDA: Serial Data I/O



### Write Cycle Timing

### SCL: Serial Clock, SDA: Serial Data I/O

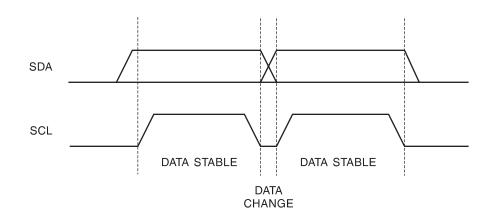


Note: 1. The write cycle time  $t_{WR}$  is the time from a valid stop condition of a write sequence to the end of the internal clear/write cycle.

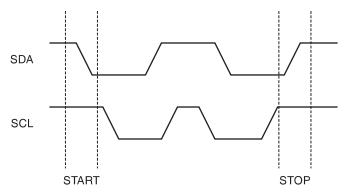




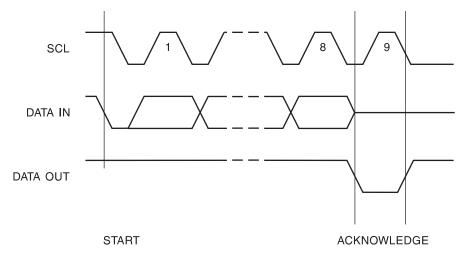
## **Data Validity**



## Start and Stop Definition



## Output Acknowledge



### **Device Addressing**

The 1K, 2K, 4K, 8K and 16K EEPROM devices all require an 8-bit device address word following a start condition to enable the chip for a read or write operation (refer to Figure 1).

The device address word consists of a mandatory one, zero sequence for the first four most significant bits as shown. This is common to all the EEPROM devices.

The next 3 bits are the A2, A1 and A0 device address bits for the 1K/2K EEPROM. These 3 bits must compare to their corresponding hard-wired input pins.

The 4K EEPROM only uses the A2 and A1 device address bits with the third bit being a memory page address bit. The two device address bits must compare to their corresponding hard-wired input pins. The A0 pin is no connect.

The 8K EEPROM only uses the A2 device address bit with the next 2 bits being for memory page addressing. The A2 bit must compare to its corresponding hard-wired input pin. The A1 and A0 pins are no connect.

The 16K does not use any device address bits but instead the 3 bits are used for memory page addressing. These page addressing bits on the 4K, 8K and 16K devices should be considered the most significant bits of the data word address which follows. The A0, A1 and A2 pins are no connect.

The eighth bit of the device address is the read/write operation select bit. A read operation is initiated if this bit is high and a write operation is initiated if this bit is low.

Upon a compare of the device address, the EEPROM will output a zero. If a compare is not made, the chip will return to a standby state.

### Write Operations

**BYTE WRITE:** A write operation requires an 8-bit data word address following the device address word and acknowledgment. Upon receipt of this address, the EEPROM will again respond with a zero and then clock in the first 8-bit data word. Following receipt of the 8-bit data word, the EEPROM will output a zero and the addressing device, such as a microcontroller, must terminate the write sequence with a stop condition. At this time the EEPROM enters an internally timed write cycle, t<sub>WR</sub>, to the nonvolatile memory. All inputs are disabled during this write cycle and the EEPROM will not respond until the write is complete (refer to Figure 2).

**PAGE WRITE:** The 1K/2K EEPROM is capable of an 8-byte page write, and the 4K, 8K and 16K devices are capable of 16-byte page writes.

A page write is initiated the same as a byte write, but the microcontroller does not send a stop condition after the first data word is clocked in. Instead, after the EEPROM acknowledges receipt of the first data word, the microcontroller can transmit up to seven (1K/2K) or fifteen (4K, 8K, 16K) more data words. The EEPROM will respond with a zero after each data word received. The microcontroller must terminate the page write sequence with a stop condition (refer to Figure 3).

The data word address lower three (1K/2K) or four (4K, 8K, 16K) bits are internally incremented following the receipt of each data word. The higher data word address bits are not incremented, retaining the memory page row location. When the word address, internally generated, reaches the page boundary, the following byte is placed at the beginning of the same page. If more than eight (1K/2K) or sixteen (4K, 8K, 16K) data words are transmitted to the EEPROM, the data word address will "roll over" and previous data will be overwritten.





**ACKNOWLEDGE POLLING:** Once the internally timed write cycle has started and the EEPROM inputs are disabled, acknowledge polling can be initiated. This involves sending a start condition followed by the device address word. The read/write bit is representative of the operation desired. Only if the internal write cycle has completed will the EEPROM respond with a zero allowing the read or write sequence to continue.

### Read Operations

Read operations are initiated the same way as write operations with the exception that the read/write select bit in the device address word is set to one. There are three read operations: current address read, random address read and sequential read.

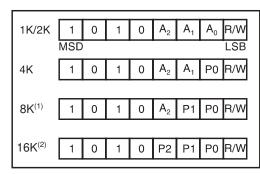
**CURRENT ADDRESS READ:** The internal data word address counter maintains the last address accessed during the last read or write operation, incremented by one. This address stays valid between operations as long as the chip power is maintained. The address "roll over" during read is from the last byte of the last memory page to the first byte of the first page. The address "roll over" during write is from the last byte of the current page to the first byte of the same page.

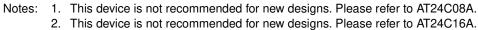
Once the device address with the read/write select bit set to one is clocked in and acknowledged by the EEPROM, the current address data word is serially clocked out. The microcontroller does not respond with an input zero but does generate a following stop condition (refer to Figure 4).

**RANDOM READ:** A random read requires a "dummy" byte write sequence to load in the data word address. Once the device address word and data word address are clocked in and acknowledged by the EEPROM, the microcontroller must generate another start condition. The microcontroller now initiates a current address read by sending a device address with the read/write select bit high. The EEPROM acknowledges the device address and serially clocks out the data word. The microcontroller does not respond with a zero but does generate a following stop condition (refer to Figure 5).

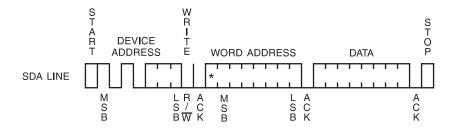
**SEQUENTIAL READ:** Sequential reads are initiated by either a current address read or a random address read. After the microcontroller receives a data word, it responds with an acknowledge. As long as the EEPROM receives an acknowledge, it will continue to increment the data word address and serially clock out sequential data words. When the memory address limit is reached, the data word address will "roll over" and the sequential read will continue. The sequential read operation is terminated when the microcontroller does not respond with a zero but does generate a following stop condition (refer to Figure 6).

#### Figure 1. Device Address

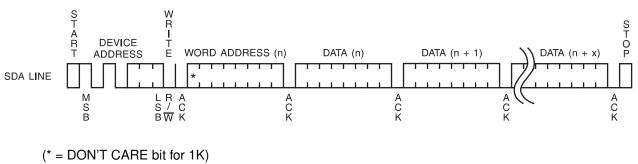




#### Figure 2. Byte Write











#### Figure 4. Current Address Read

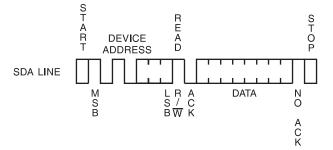
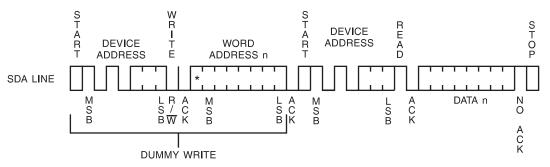
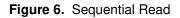
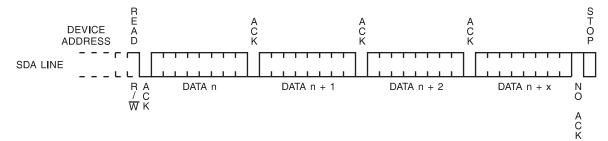


Figure 5. Random Read



(\* = DON'T CARE bit for 1K)





## AT24C01A Ordering Information

Ordering Code	Package	Operation Range
AT24C01A-10PI-2.7	8P3	
AT24C01A-10SI-2.7	8S1	
AT24C01A-10TI-2.7	8A2	
AT24C01AY1-10YI-2.7	8Y1	Industrial
AT24C01A-10TSI-2.7	5TS1	(-40°C to 85°C)
AT24C01AR-10TSI-2.7	5TS1	
AT24C01AU3-10UI-2.7	8U3-1	
AT24C01A-10PI-1.8	8P3	
AT24C01A-10SI-1.8	8S1	
AT24C01A-10TI-1.8	8A2	Industrial
AT24C01AY1-10YI-1.8	8Y1	(-40°C to 85°C)
AT24C01A-10TSI-1.8	5TS1	( ,
AT24C01AU3-10UI-1.8	8U3-1	
AT24C01A-10SU-2.7	8S1	
AT24C01A-10SU-1.8	8S1	Lead-free/Halogen-free/
AT24C01A-10TU-2.7	8A2	Industrial Temperature
AT24C01A-10TU-1.8	8A2	(-40°C to 85°C)
AT24C01A-10SE-2.7	961	High Grade/Extended Temp
AI 2400 I A- 100E-2.7	8S1	(-40°C to 125°C)
		Lead-free/Halogen-free/
AT24C01A-10SQ-2.7	8S1	High Grade/Extended Temp
		(-40°C to 125°C)

Note: For 2.7V devices used in the 4.5V to 5.5V range, please refer to performance values in the AC and DC characteristics table.

	Package Type				
8P3	8-lead, 0.300" Wide, Plastic Dual Inline Package (PDIP)				
8S1	8-lead, 0.150" Wide, Plastic Gull Wing Small Outline (JEDEC SOIC)				
8A2	8-lead, 0.170" Wide, Thin Shrink Small Outline Package (TSSOP)				
8Y1	8-lead, 4.90 mm x 3.00 mm Body, Dual Footprint, Non-leaded, Miniature Array Package (MAP)				
5TS1	5-lead, 2.90 mm x 1.60 mm Body, Plastic Thin Shrink Small Outline Package (SOT23)				
8U3-1	8-ball, die Ball Grid Away Package (dBGA2)				
	Options				
-2.7	Low-voltage (2.7V to 5.5V)				
-1.8	Low-voltage (1.8V to 5.5V)				
R	Rotated Pinout				





## AT24C02 Ordering Information

Ordering Code	Package	Operation Range
AT24C02-10PI-2.7	8P3	
AT24C02N-10SI-2.7	8S1	
AT24C02-10TI-2.7	8A2	Industrial
AT24C02Y1-10YI-2.7	8Y1	(-40°C to 85°C)
AT24C02-10TSI-2.7	5TS1	
AT24C02U3-10UI-2.7	8U3-1	
AT24C02-10PI-1.8	8P3	
AT24C02N-10SI-1.8	8S1	
AT24C02-10TI-1.8	8A2	Industrial
AT24C02Y1-10YI-1.8	8Y1	(-40°C to 85°C)
AT24C02-10TSI-1.8	5TS1	
AT24C02U3-10UI-1.8	8U3-1	
AT24C02N-10SU-2.7	8S1	
AT24C02N-10SU-1.8	8S1	Lead-free/Halogen-free/
AT24C02-10TU-2.7	8A2	Industrial Temperature
AT24C02-10TU-1.8	8A2	(-40°C to 85°C)
	901	High Grade/Extended Temp
AT24C02N-10SE-2.7	8S1	(-40°C to 125°C)
		Lead-free/Halogen-free/
AT24C02N-10SQ-2.7	8S1	High Grade/Extended Temp
		(-40°C to 125°C)

Note: For 2.7V devices used in the 4.5V to 5.5V range, please refer to performance values in the AC and DC characteristics table.

	Package Type				
8P3	8-lead, 0.300" Wide, Plastic Dual Inline Package (PDIP)				
8S1	8-lead, 0.150" Wide, Plastic Gull Wing Small Outline (JEDEC SOIC)				
8A2	8-lead, 0.170" Wide, Thin Shrink Small Outline Package (TSSOP)				
8Y1	8-lead, 4.90 mm x 3.00 mm Body, Dual Footprint, Non-leaded, Miniature Array Package (MAP)				
5TS1	5-lead, 2.90 mm x 1.60 mm Body, Plastic Thin Shrink Small Outline Package (SOT23)				
8U3-1	8-ball, die Ball Grid Away Package (dBGA2)				
	Options				
-2.7	Low-voltage (2.7V to 5.5V)				
-1.8	Low-voltage (1.8V to 5.5V)				

## 14 AT24C01A/02/04/08/16

## AT24C01A/02/04/08/16

## AT24C04 Ordering Information

Ordering Code	Package	Operation Range
AT24C04-10PI-2.7	8P3	Industrial
AT24C04N-10SI-2.7	8S1	(-40°C to 85°C)
AT24C04-10TI-2.7	8A2	
AT24C04Y1-10YI-2.7	8Y1	
AT24C04-10TSI-2.7	5TS1	
AT24C04U3-10UI-2.7	8U3-1	
AT24C04-10PI-1.8	8P3	Industrial
AT24C04N-10SI-1.8	8S1	(-40°C to 85°C)
AT24C04-10TI-1.8	8A2	(
AT24C04Y1-10YI-1.8	8Y1	
AT24C04-10TSI-1.8	5TS1	
AT24C04U3-10UI-1.8	8U3-1	
AT24C04N-10SU-2.7	8S1	
AT24C04N-10SU-1.8	8S1	Lead-free/Halogen-free/
AT24C04-10TU-2.7	8A2	Industrial Temperature
AT24C04-10TU-1.8	8A2	(-40°C to 85°C)
AT24C04N-10SE-2.7	8S1	High Grade/Extended Temp
		(-40°C to 125°C)
		Lead-free/Halogen-free/
AT24C04N-10SQ-2.7	8S1	High Grade/Extended Temp
		(-40°C to 125°C)

Note: For 2.7V devices used in the 4.5V to 5.5V range, please refer to performance values in the AC and DC characteristics table.

	Package Type				
8P3	8-lead, 0.300" Wide, Plastic Dual Inline Package (PDIP)				
8S1	8-lead, 0.150" Wide, Plastic Gull Wing Small Outline (JEDEC SOIC)				
8A2	8-lead, 0.170" Wide, Thin Shrink Small Outline Package (TSSOP)				
8Y1	8-lead, 4.90 mm x 3.00 mm Body, Dual Footprint, Non-leaded, Miniature Array Package (MAP)				
5TS1	5-lead, 2.90 mm x 1.60 mm Body, Plastic Thin Shrink Small Outline Package (SOT23)				
8U3-1	8-ball, die Ball Grid Away Package (dBGA2)				
Options					
-2.7	Low-voltage (2.7V to 5.5V)				
-1.8	Low-voltage (1.8V to 5.5V)				





## AT24C08<sup>(2)</sup> Ordering Information

Ordering Code	Package	Operation Range
AT24C08-10PI-2.7 AT24C08N-10SI-2.7 AT24C08-10TI-2.7	8P3 8S1 8A2	Industrial (-40°C to 85°C)
AT24C08-10PI-1.8 AT24C08N-10SI-1.8 AT24C08-10TI-1.8	8P3 8S1 8A2	Industrial (-40°C to 85°C)

Notes: 1. For 2.7V devices used in the 4.5V to 5.5V range, please refer to performance values in the AC and DC characteristics table. 2. This device is not recommended for new designs. Please refer to AT24C08A.

Package Type		
8P3	8-lead, 0.300" Wide, Plastic Dual Inline Package (PDIP)	
8S1	8-lead, 0.150" Wide, Plastic Gull Wing Small Outline (JEDEC SOIC)	
8A2	8-lead, 0.170" Wide, Thin Shrink Small Outline Package (TSSOP)	
Options		
-2.7	Low-voltage (2.7V to 5.5V)	
-1.8	Low-voltage (1.8V to 5.5V)	

## AT24C16<sup>(2)</sup> Ordering Information

Ordering Code	Package	Operation Range
AT24C16-10PI-2.7 AT24C16N-10SI-2.7 AT24C16-10TI-2.7	8P3 8S1 8A2	Industrial (-40°C to 85°C)
AT24C16-10PI-1.8 AT24C16N-10SI-1.8 AT24C16-10TI-1.8	8P3 8S1 8A2	Industrial (-40°C to 85°C)

Notes: 1. For 2.7V devices used in the 4.5V to 5.5V range, please refer to performance values in the AC and DC characteristics table. 2. This device is not recommended for new designs. Please refer to AT24C16A.

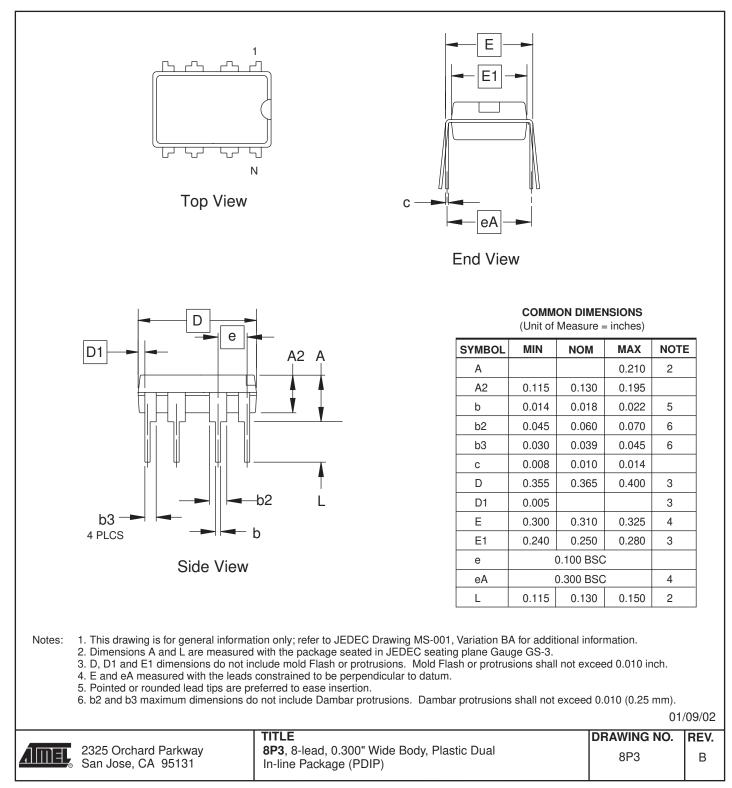
Package Type			
8P3	8-lead, 0.300" Wide, Plastic Dual Inline Package (PDIP)		
8S1	8-lead, 0.150" Wide, Plastic Gull Wing Small Outline (JEDEC SOIC)		
8A2	8-lead, 0.170" Wide, Thin Shrink Small Outline Package (TSSOP)		
	Options		
-2.7	Low-voltage (2.7V to 5.5V)		
-1.8	Low-voltage (1.8V to 5.5V)		





### **Packaging Information**

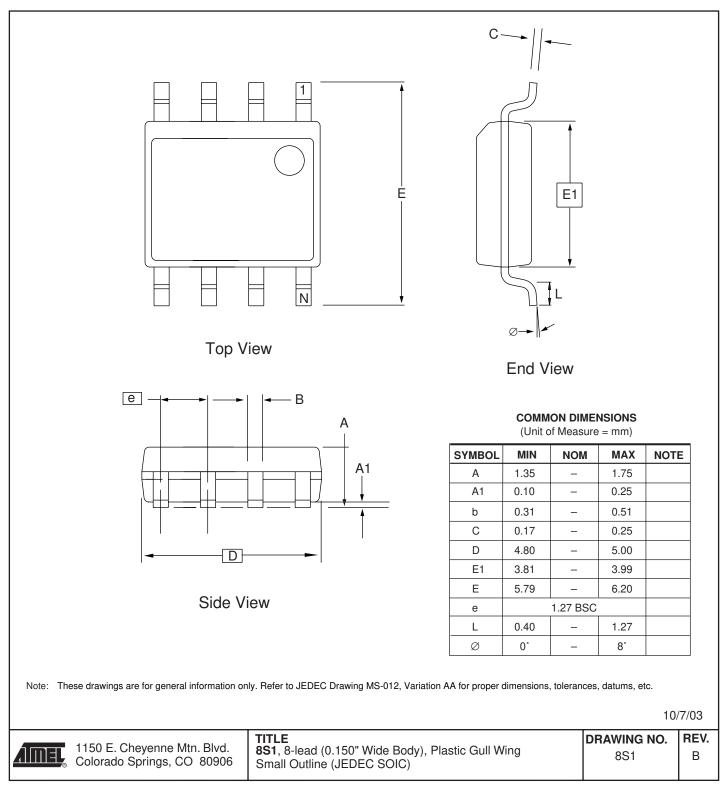
### 8P3 – PDIP



## 18 AT24C01A/02/04/08/16

## AT24C01A/02/04/08/16

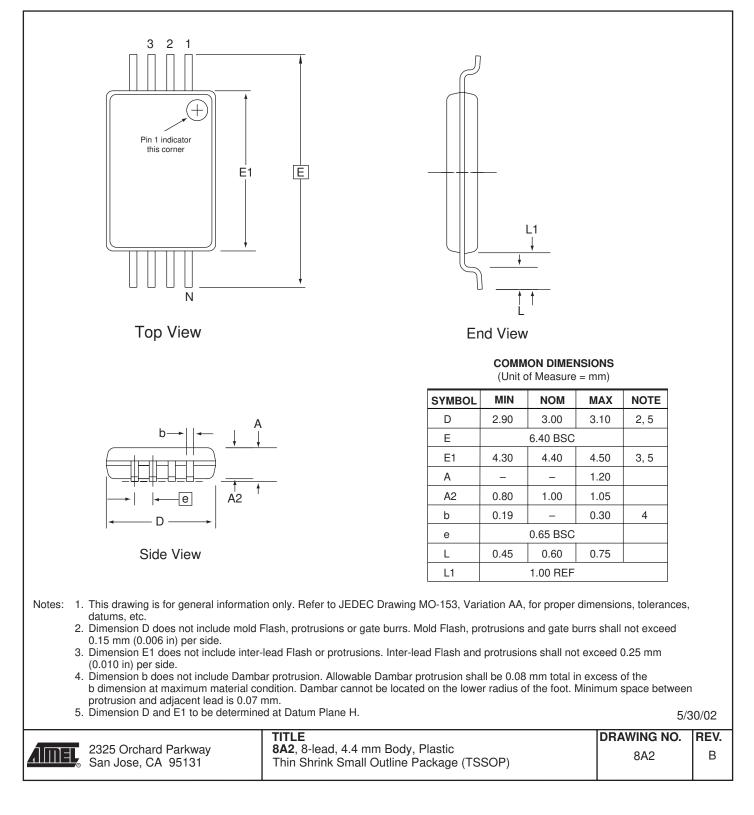
### 8S1 – JEDEC SOIC



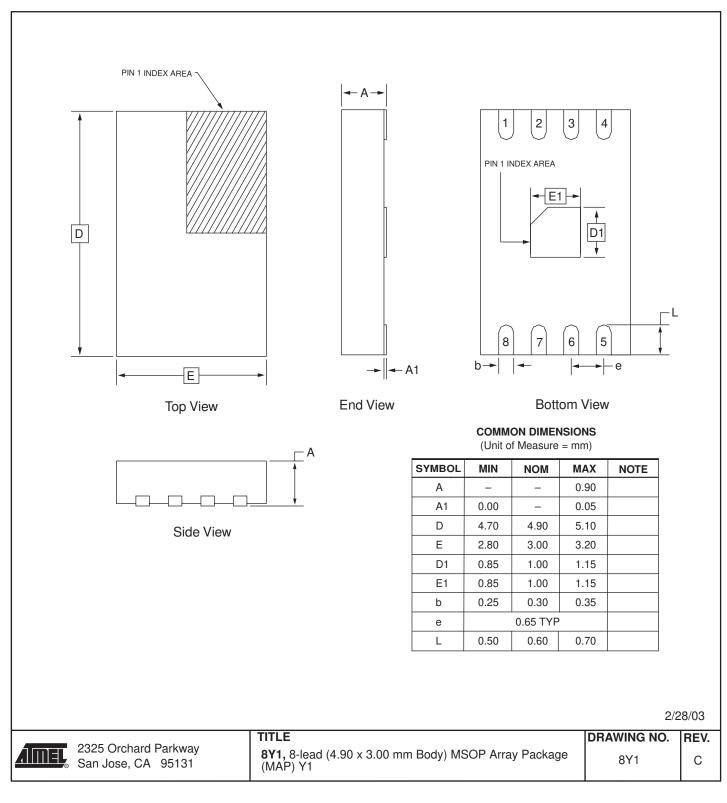




### 8A2 – TSSOP



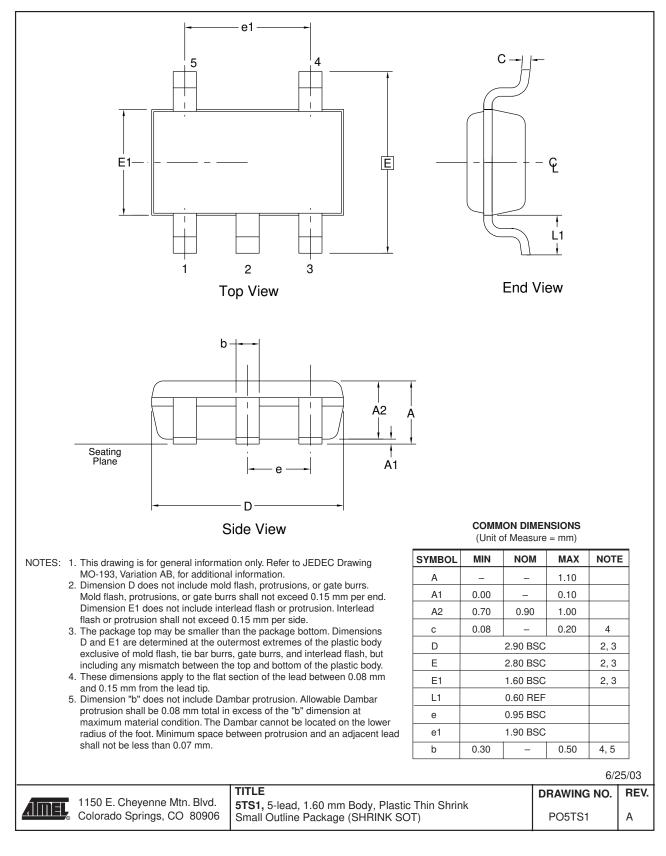
8Y1 – MAP







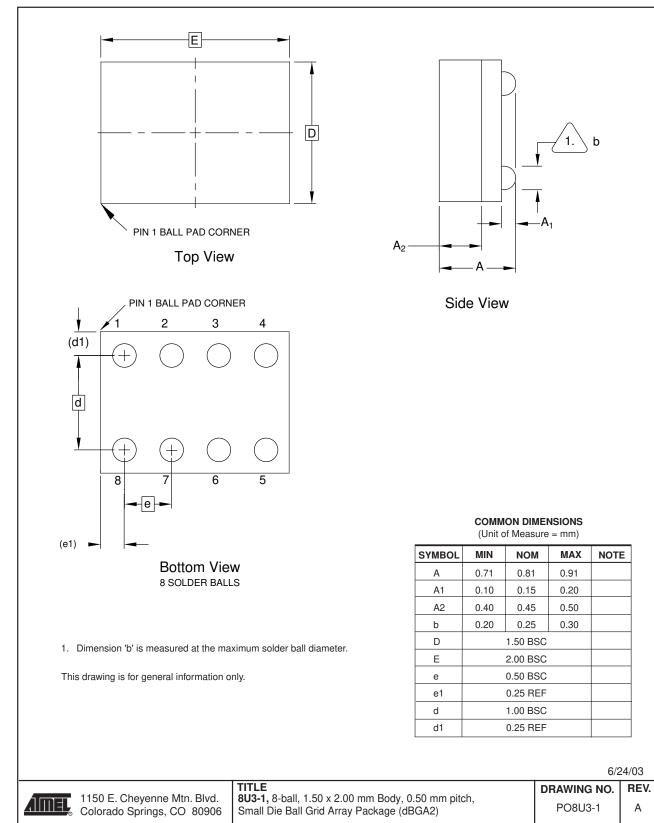
### 5TS1 - SOT23



AT24C01A/02/04/08/16

## AT24C01A/02/04/08/16

### 8U3-1 - dBGA2







### **Atmel Corporation**

2325 Orchard Parkway San Jose, CA 95131, USA Tel: 1(408) 441-0311 Fax: 1(408) 487-2600

#### **Regional Headquarters**

#### Europe

Atmel Sarl Route des Arsenaux 41 Case Postale 80 CH-1705 Fribourg Switzerland Tel: (41) 26-426-5555 Fax: (41) 26-426-5500

#### Asia

Room 1219 Chinachem Golden Plaza 77 Mody Road Tsimshatsui East Kowloon Hong Kong Tel: (852) 2721-9778 Fax: (852) 2722-1369

#### Japan

9F, Tonetsu Shinkawa Bldg. 1-24-8 Shinkawa Chuo-ku, Tokyo 104-0033 Japan Tel: (81) 3-3523-3551 Fax: (81) 3-3523-7581

### **Atmel Operations**

Memory

2325 Orchard Parkway San Jose, CA 95131, USA Tel: 1(408) 441-0311 Fax: 1(408) 436-4314

#### Microcontrollers

2325 Orchard Parkway San Jose, CA 95131, USA Tel: 1(408) 441-0311 Fax: 1(408) 436-4314

La Chantrerie BP 70602 44306 Nantes Cedex 3, France Tel: (33) 2-40-18-18-18 Fax: (33) 2-40-18-19-60

#### ASIC/ASSP/Smart Cards

Zone Industrielle 13106 Rousset Cedex, France Tel: (33) 4-42-53-60-00 Fax: (33) 4-42-53-60-01

1150 East Cheyenne Mtn. Blvd. Colorado Springs, CO 80906, USA Tel: 1(719) 576-3300 Fax: 1(719) 540-1759

Scottish Enterprise Technology Park Maxwell Building East Kilbride G75 0QR, Scotland Tel: (44) 1355-803-000 Fax: (44) 1355-242-743

#### **RF**/Automotive

Theresienstrasse 2 Postfach 3535 74025 Heilbronn, Germany Tel: (49) 71-31-67-0 Fax: (49) 71-31-67-2340

1150 East Cheyenne Mtn. Blvd. Colorado Springs, CO 80906, USA Tel: 1(719) 576-3300 Fax: 1(719) 540-1759

### Biometrics/Imaging/Hi-Rel MPU/

High Speed Converters/RF Datacom Avenue de Rochepleine BP 123 38521 Saint-Egreve Cedex, France Tel: (33) 4-76-58-30-00 Fax: (33) 4-76-58-34-80

*Literature Requests* www.atmel.com/literature

**Disclaimer:** Atmel Corporation makes no warranty for the use of its products, other than those expressly contained in the Company's standard warranty which is detailed in Atmel's Terms and Conditions located on the Company's web site. The Company assumes no responsibility for any errors which may appear in this document, reserves the right to change devices or specifications detailed herein at any time without notice, and does not make any commitment to update the information contained herein. No licenses to patents or other intellectual property of Atmel are granted by the Company in connection with the sale of Atmel products, expressly or by implication. Atmel's products are not authorized for use as critical components in life support devices or systems.

© Atmel Corporation 2004. All rights reserved. Atmel<sup>®</sup> and combinations thereof, are the registered trademarks, and dBGA<sup>™</sup> is the trademark of Atmel Corporation or its subsidiaries. Other terms and product names may be the trademarks of others.

